

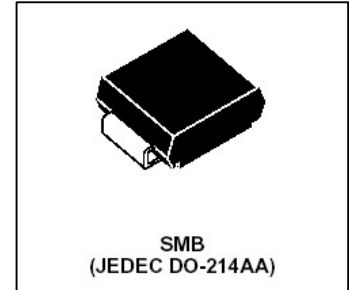


WES806SMC

Thyristor Surge Protector

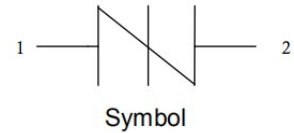
Features

- Integrated Bi-directional thyristor for Surge Protection
- High surge capability
- High off-state impedance
- Low leakage current
- Short-circuit failure mode



Main Application

- Data lines and security systems.
- CATV line amplifiers and power inserters.
- Sprinkler systems.



Parameter	Symbol	Value	Unit
Non-repetitive peak impulse current 10/1000 μ s (Telcordia GR-1089-CORE)	I_{PPSM}	75	A
Non-repetitive peak impulse Voltage 10/700 μ s (ITU-T K.20, K.21 & K.44,K.45)	V_{PPSM}	4000	V

Electrical Parameters ($T_A=25^\circ\text{C}$)

Part Number	V_{DRM}	I_{DRM}	V_{BO}	I_{BO}	V_T	I_T	I_H	C_o
	Max.	Max.	Max.	Max.	Max.	Max.	Min.	Typ.
	V	μ A	V	mA	V	A	mA	pF
WES806SMC	6	5	25	800	4	2.2	15	20

V_{DRM} : Stand-off voltage, is measured at I_{DRM} .

I_{DRM} : Leakage current at V_{DRM} .

V_{BO} : Breakover voltage, is measured at 100V/ μ s.

I_{BO} : Breakover current.

V_T : On-state voltage.

I_T : On-state current.

C_o : Off-state capacitance.

I_H : Holding current.

I_{PP} : Peak pulse current, is a repetitive surge rating and is guaranteed for the life of the product.

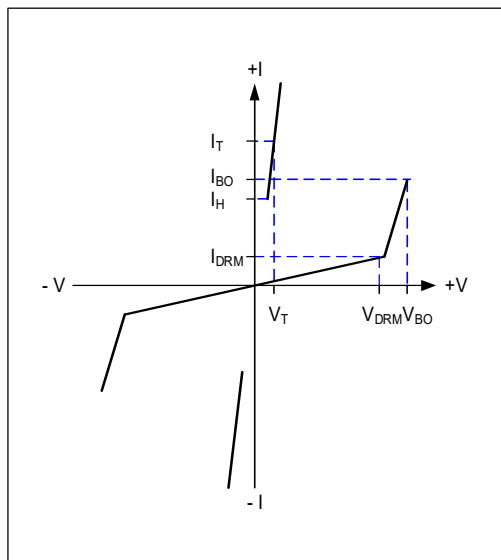
V_{ppsm} : Peak pulse voltage, is a repetitive surge rating and is guaranteed for the life of the product.

General Notes:

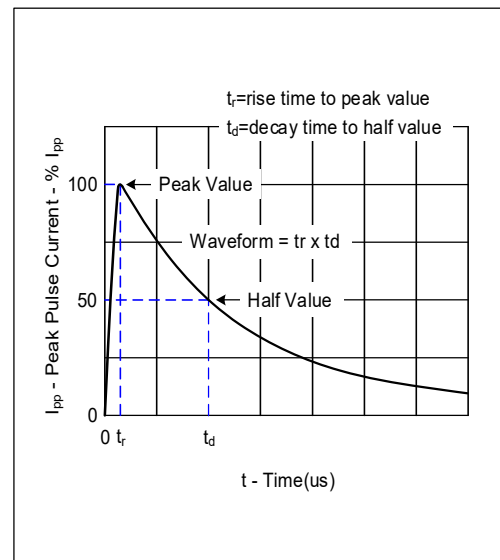
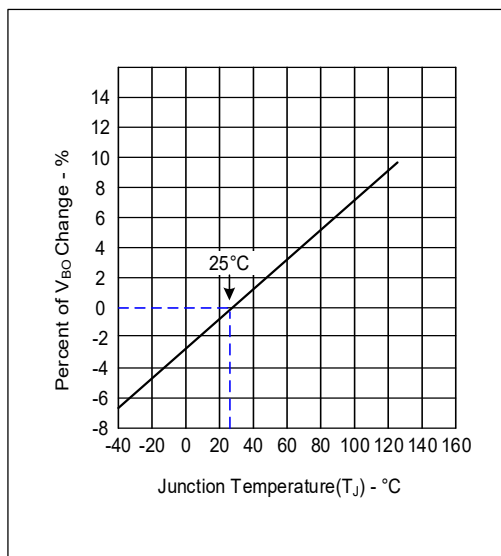
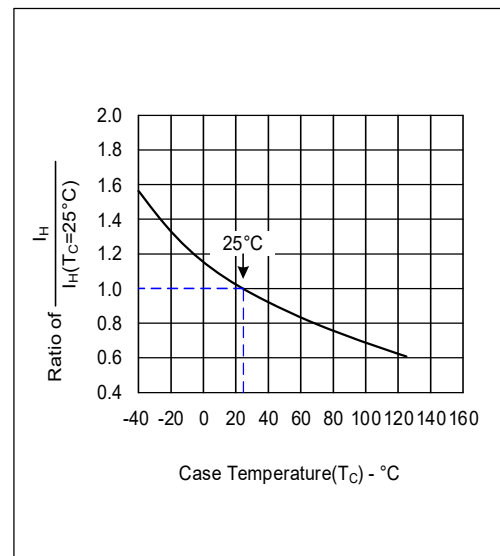
- All measurements are made at an ambient temperature of 25 °C. IPP applies to -40 °C through +85 °C temperature range.
- Listed WES devices are bi-directional. All electrical parameters and surge ratings apply to forward and reverse polarities.
- Special voltage (VBO and VDRM) and holding current (IH) requirements are available up on request.
- Off-state capacitance is measured at 1 MHz with a 2 V bias.

Thermal Resistances

Symbol	Parameter	Value	Unit
Ts	Storage temperature range	-55 to +150	°C
Tj	Junction temperature range	-40 to +125	°C

Electrical Characteristics Curves

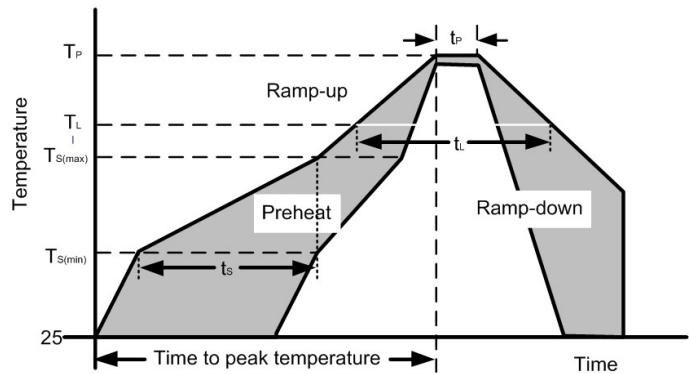
V - I Characteristics

 $t_r \times t_d$ Pulse WaveformNormalized V_{BO} Change versus Junction Temperature

Normalized DC Holding Current versus Case Temperature

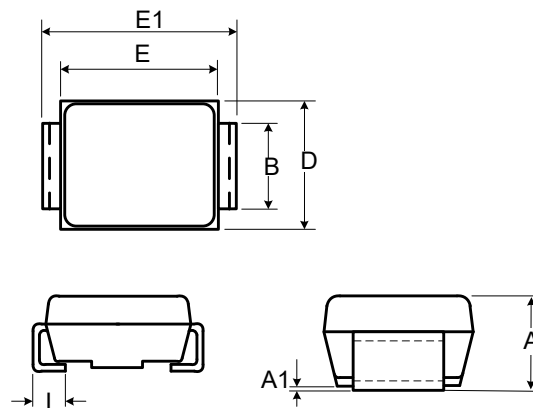
Soldering Parameters

Reflow Condition		
Pre Heat	Temperature Min ($T_{s(min)}$)	150°C
	Temperature Max ($T_{s(max)}$)	200°C
	Time (min to max) (t_s)	60-190 s
Average ramp up rate (Liquidus Temp) (T_L) to peak		3°C/s max
$T_{s(max)}$ to T_L - Ramp-up Rate		3°C/s max
Reflow	Temperature (T_L) (Liquidus)	217°C
	Temperature (t_L)	60-150 s
Peak Temperature (T_P)		260 ^{+0/-5} °C
Time within actual peak Temperature (t_p)		20-40 s
Ramp-down Rate		5°C/s max
Time 25°C to peak Temperature (T_P)		8 minutes Max.
Do not exceed		260°C



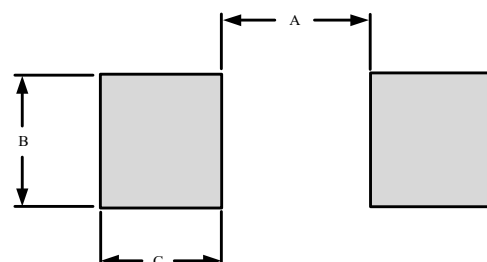
Product Dimensions

Ref. (mm)	Min.	Max.
A	2.130	2.600
A1	-	0.300
B	1.900	2.200
E	4.100	4.750
E1	5.210	5.590
D	3.300	3.940
L	0.760	1.520

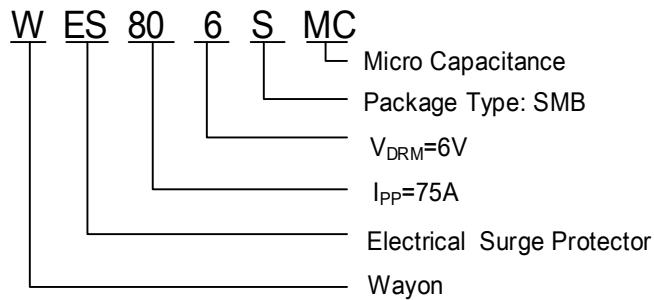


Recommended Solder Pad Layout

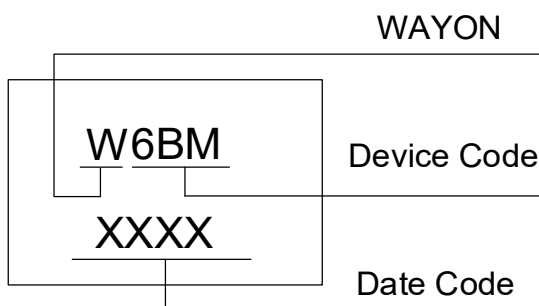
DIM(mm)	MILLIMETERS
A	2.74
B	2.26
C	2.16



Part Numbering System and Marking



Marking:



Package Information

Package Type	Description	Quantity (pcs)
SMB(DO-214AA)	Tape & Reel Pack	2500

Contact Information

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For additional information, please contact your local Sales Representative.



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Specifications are subject to change without notice.
The device characteristics and parameters in this data sheet can and do vary in different applications and actual device performance may vary over time.
Users should verify actual device performance in their specific applications.